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[Samsung Electro-Mechanics America, Inc.](#)
[CL31B332KGFNNNE](#)

For any questions, you can email us directly:

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SAMSUNG
ELECTRO-MECHANICS



SPECIFICATION

- Supplier : Samsung electro-mechanics
- Product : Multi-layer Ceramic Capacitor

- Samsung P/N : **CL31B332KGFNNNE**
- Description : **CAP, 3.3nF, 500V, ±10%, X7R, 1206**

A. Samsung Part Number

CL 31 B 332 K G F N N N E
 ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪

① Series	Samsung Multi-layer Ceramic Capacitor		
② Size	1206 (inch code)	L: 3.2 ± 0.15 mm	W: 1.6 ± 0.15 mm
③ Dielectric	X7R	⑧ Inner electrode	Ni
④ Capacitance	3.3 nF	Termination	Cu
⑤ Capacitance tolerance	±10 %	Plating	Sn 100% (Pb Free)
⑥ Rated Voltage	500 V	⑨ Product	Normal
⑦ Thickness	1.25 ± 0.15 mm	⑩ Special	Reserved for future use
		⑪ Packaging	Embossed Type, 7" reel

B. Samsung Reliability Test and Judgement condition

	Performance	Test condition
Capacitance	Within specified tolerance	1 kHz ± 10% 1.0 ± 0.2 Vrms
Tan δ (DF)	0.025 max.	
Insulation Resistance	10,000 Mohm or 500 Mohm · μF Whichever is Smaller	Rated Voltage 60 ~ 120 sec.
Appearance	No abnormal exterior appearance	Microscope (×10)
Withstanding Voltage	No dielectric breakdown or mechanical breakdown	150% of the rated voltage
Temperature Characterisitcs	X7R (From -55°C to 125°C, Capacitance change should be within ±15%)	
Adhesive Strength of Termination	No peeling shall be occur on the terminal electrode	500g-F, for 10 ± 1 sec.
Bending Strength	Capacitance change : within ±12.5%	Bending to the limit (1mm) with 1.0mm/sec.
Solderability	More than 75% of terminal surface is to be soldered newly	SnAg3.0Cu0.5 solder 245 ± 5°C, 3 ± 0.3sec. (preheating : 80 ~ 120°C for 10 ~ 30sec.)
Resistance to Soldering heat	Capacitance change : within ±7.5% Tan δ, IR : initial spec.	Solder pot : 270 ± 5°C, 10 ± 1sec.

	Performance	Test condition
Vibration Test	Capacitance change : within $\pm 5\%$ Tan δ , IR : initial spec.	Amplitude : 1.5mm From 10Hz to 55Hz (return : 1min.) 2hours \times 3 direction (x, y, z)
Moisture Resistance	Capacitance change : within $\pm 12.5\%$ Tan δ : 0.05 max IR : 500Mohm or 25Mohm $\cdot \mu F$ Whichever is Smaller	With rated voltage 40 \pm 2 $^{\circ}$ C, 90~95%RH, 500+12/-0hrs
High Temperature Resistance	Capacitance change : within $\pm 12.5\%$ Tan δ : 0.05 max IR : 1000Mohm or 50Mohm $\cdot \mu F$ Whichever is Smaller	With 150% of the rated voltage Max. operating temperature 1000+48/-0hrs
Temperature Cycling	Capacitance change : within $\pm 7.5\%$ Tan δ , IR : initial spec.	1 cycle condition Min. operating temperatur \rightarrow 25 $^{\circ}$ C \rightarrow Max. operating temperature \rightarrow 25 $^{\circ}$ C 5 cycle test

C. Recommended Soldering method :

Reflow (Reflow Peak Temperature : 260+0/-5 $^{\circ}$ C, 10sec. Max)

* For the more detail Specification, Please refer to the Samsung MLCC catalogue.